

#### **N-Channel Enhancement Mode Field Effect Transistor**

# **General Description**

The CMN3400M uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

#### **Features**

- RDS(ON)<32mΩ @ VGS=4.5V
- RDS(ON)<36mΩ @ VGS=2.5V
- Simple drive requirement
- Surface mount package

## **Product Summary**

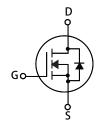
BVDSS	RDSON	ID
30V	32mΩ	6A

# **Applications**

- PWM applications
- Load switch
- Power management
- PA Switch

# **SOT-23 Pin Configuration**





Туре	Package	Marking
CMN3400M	SOT-23	AOL

## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	30	V	
V <sub>GS</sub>	Gate-Source Voltage	±12	V	
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current	6	А	
I <sub>DM</sub>	Pulsed Drain Current	18	А	
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation	1.4	W	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
T <sub>J</sub>	Operating Junction Temperature Range -55 to		°C	

# **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction-ambient (Steady State)		89	°C/W



#### **N-Channel Enhancement Mode Field Effect Transistor**

# Electrical Characteristics (T<sub>J</sub>=25 ℃, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
В	Static Drain-Source On-Resistance	V <sub>GS</sub> =4.5V , I <sub>D</sub> =5A			32	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =2.5V , I <sub>D</sub> =4A			36	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	0.5		1.5	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =24V, V <sub>GS</sub> =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 12V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =5A		12		S
$Q_g$	Total Gate Charge	I <sub>D</sub> =5.8A		13		
$Q_gs$	Gate-Source Charge	V <sub>DS</sub> =15V		2		nC
$Q_gd$	Gate-Drain Charge	V <sub>GS</sub> = 10V		3		
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =15V		6		
Tr	Rise Time	R <sub>L</sub> =6 Ω		4		no
$T_{d(off)}$	Turn-Off Delay Time	V <sub>GS</sub> =10V		16		ns
T <sub>f</sub>	Fall Time	$R_{GEN} = 3\Omega$		5		
C <sub>iss</sub>	Input Capacitance			700		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		65.2		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			54		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =1A			1	V

This product has been designed and qualified for the counsumer market. Cmos assumes no liability for customers' product design or applications. Cmos reserver the right to improve product design ,functions and reliability wihtout notice.